

Ultra Power Line Series

❖ Features

- High Current characteristics
- Low Rdc characteristics
- Good reliability (Monolithic structure)
- Magnetically shielded
- Fast mounting speed
- RoHS compliant

❖ Applications

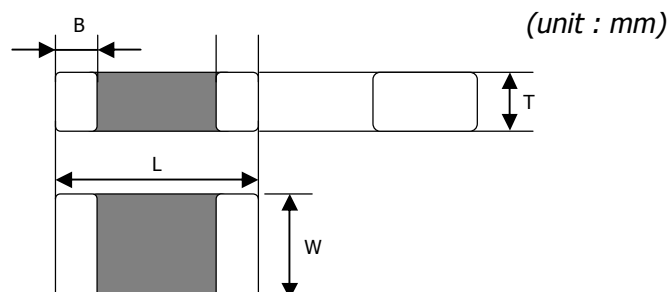
- PDP/LCD Monitor, Digital TV/VCR etc.

❖ General Code

CB	2012	U	A	300	T
1	2	3	4	5	6

- Series Code**
CB : Chip Ferrite Beads
- Dimension Code**
The first two digits : length(mm)
The last two digits : width(mm)
- Application Code**
G : Signal Line
P : High Current Line
U : Ultra High Current Line
- Material Code**
A: General Frequency
K,J: Medium Frequency
M: High Frequency
V: Very High Frequency
- Impedance Value Code**
The first two digits represents significant
The last digit is the number of zeros following
ex) 300 = 30 (Ω)
- Packaging Code**
T : Reel paper packaging
E : Reel embossed tape packaging

❖ Dimensions

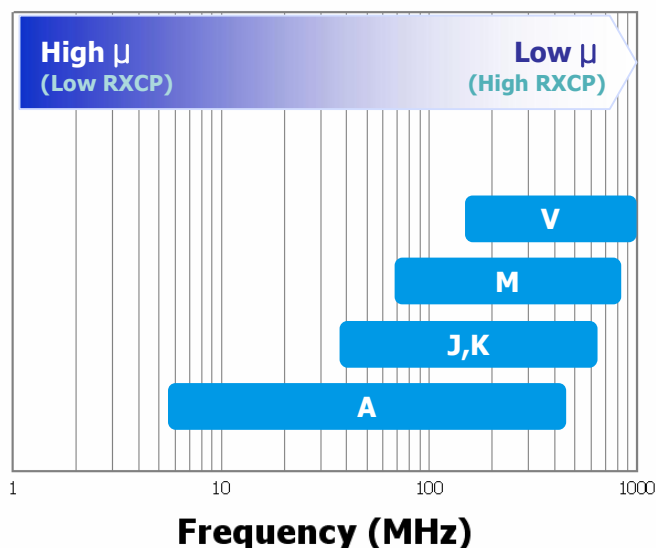


Size	L	W	T	B
1005	1.0±0.10	0.5±0.10	0.5±0.10	0.25±0.1
1608	1.6±0.15	0.8±0.15	0.8±0.15	0.3±0.2
2012	2.0±0.20	1.25±0.2	0.85±0.2	0.5±0.3
3216	3.2±0.20	1.6±0.20	1.1±0.20	0.5±0.3
4516	4.5±0.25	1.6±0.20	1.3±0.20	0.5±0.3
4532	4.5±0.25	3.2±0.25	1.5±0.25	0.5±0.3

❖ Temperature Range

- Operating Temp. -55 ~ +125℃
- Storage Temp. -10 ~ +40 ℃

❖ Typical Material Characteristics



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CHIP BEADS, For Ultra Power Line



❖ 1608~4532 SIZE

Samwha P/N	Impedance (Ω) $\pm 25\%$	DC Resistance (Ω) max.	Rated Current (mA) max.	Test Frequency (MHz)
CB1608UA101	100	0.030	4000	100
CB1608UK500	50	0.025	4000	
CB1608UK600	60	0.030	4000	
CB2012UA300	30	0.010	5000	
CB2012UA600	60	0.015	5000	
CB2012UA101	100	0.020	4000	
CB2012UA121	120	0.030	4000	
CB2012UK121	120	0.030	4000	
CB2012UJ121	120	0.030	4000	
CB2012UM121	120	0.030	4000	
CB3216UA121	120	0.020	6000	
CB3216UM600	60	0.010	6000	
CB3216UM121	120	0.200	6000	
CB4516UM600	60	0.010	6000	
CB4532UK121	120	0.030	6000	
CB4532UK401	400	0.045	4000	

CHIP BEAD, Ultra Power Line Series

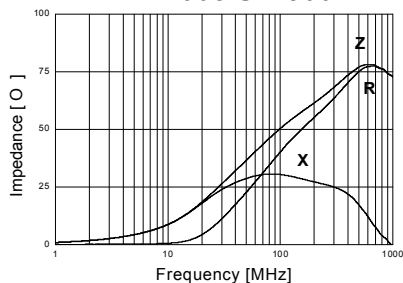
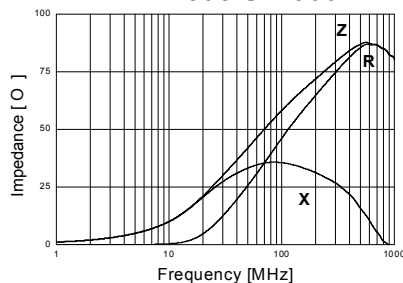
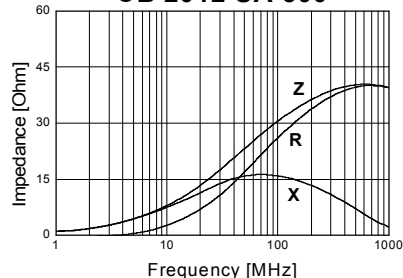
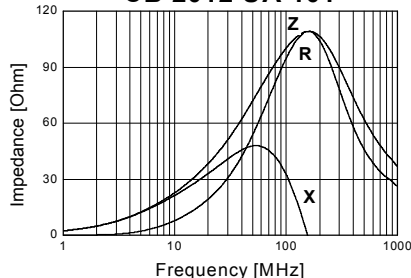
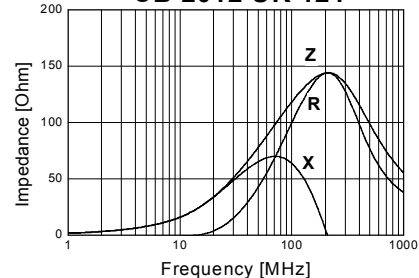
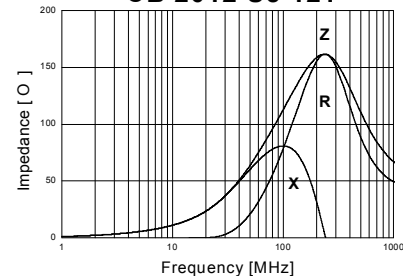
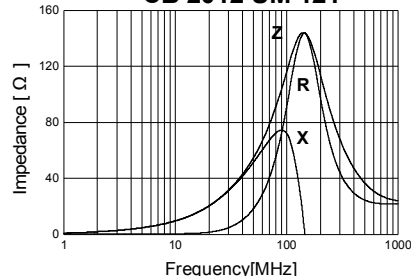
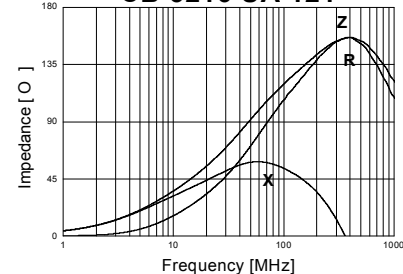
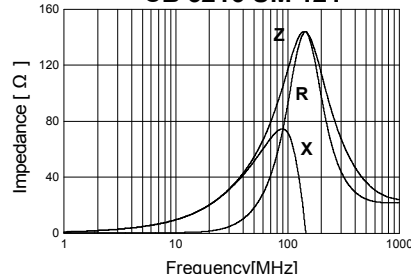
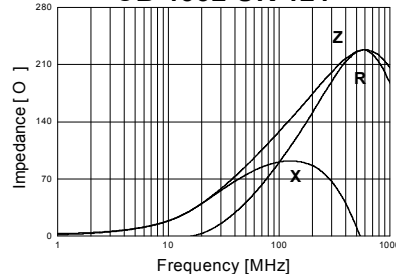
※ Measuring Equipment

-. Z : HP4291B / E4991A

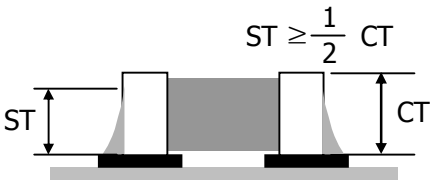
-. Rdc : HP4338B

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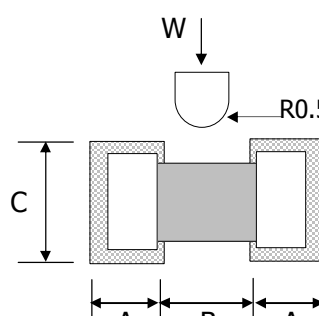
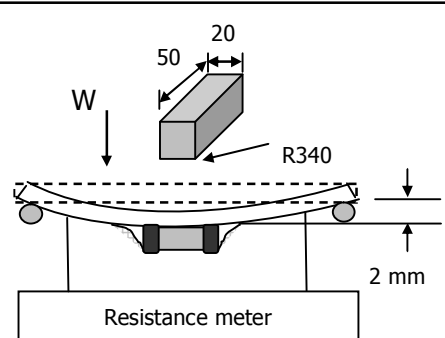
❖ 1608~4532 SIZE

CB 1608 UK 500

CB 1608 UK 600

CB 2012 UA 300

CB 2012 UA 101

CB 2012 UK 121

CB 2012 UJ 121

CB 2012 UM 121

CB 3216 UA 121

CB 3216 UM 121

CB 4532 UK 121


Reliability & Test Condition

Item	Requirements	Test Conditions
Operating temperature range	- 55 °C ~ + 125 °C	-
Storage temperature range	40 °C max., 70% RH max.	at packing condition
Solderability	More than 90% of the terminal electrode shall be covered with new solder	Preheat temperature : 100 ~ 150 °C Preheat time : 60 sec. Solder temperature : 245 ± 5 °C Soldering time : 10 ± 1 sec.
Resistance to soldering heat	1. No damage such as cracks should be caused in chip element 2. More than 75% of the terminal electrode shall be covered with new solder 3. Impedance shall not change more than ± 30 %	Preheat temperature : 100 ~ 150 °C Preheat time : 60 sec. Solder temperature : 270 ± 10 °C Soldering time : 10 ± 0.5 sec.
Reflow soldering	More than 50% of the terminal electrode shall be covered with new solder  $ST \geq \frac{1}{2} CT$	Preheat temperature : 150 °C Preheat time : 60 sec. Solder temperature : 245 ± 5 °C Soldering time : 10 sec. max. (Reflow soldering profile)
High temperature resistance	1. No mechanical damage 2. Impedance shall not change more than ± 30 %	Temperature : 125 ± 3 °C Time : 500 ± 12 hours Measurement at room ambient temperature after placing for 24 hours
High temperature load resistance		Temperature : 125 ± 3 °C Applied current : rated current Time : 1000 ± 12 hours Measurement at room ambient temperature after placing for 24 hours
Humidity resistance		Temperature : 40 ± 2 °C Humidity : 90 ± 2 % RH Time : 500 ± 12 hours Measurement at room ambient temperature after placing for 24 hours

Reliability & Test Condition

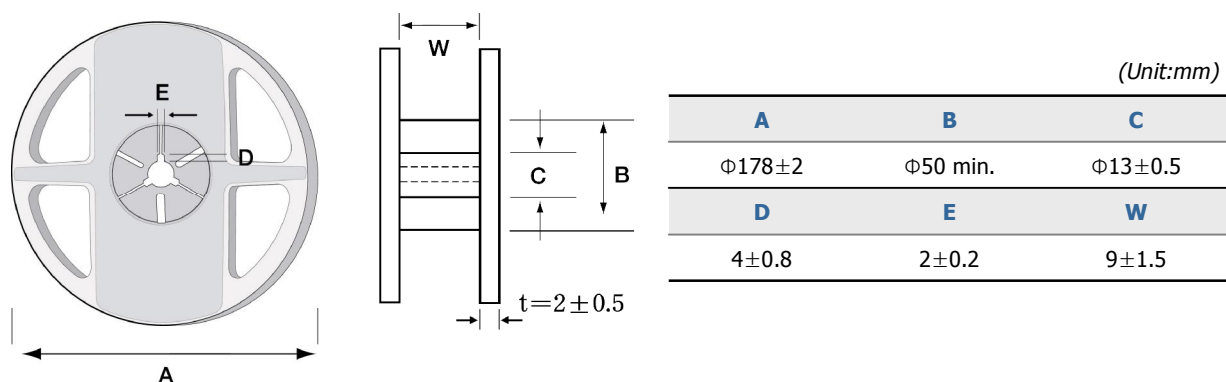
Item	Requirements	Test Conditions						
Humidity load resistance	1. No mechanical damage 2. Impedance shall not change more than $\pm 30\%$	Temperature : $40 \pm 2\text{ }^{\circ}\text{C}$ Humidity : $90 \pm 2\%$ RH Applied current : rated current Time : 500 ± 12 hours Measurement at room ambient temperature after placing for 24 hours						
Low temperature resistance		Temperature : $-55 \pm 3\text{ }^{\circ}\text{C}$ Time : 1000 ± 12 hours Measurement at room ambient temperature after placing for 24 hours						
Thermal shock		1. $-55 \pm 3^{\circ}\text{C}$ for 30 minutes 2. $125 \pm 3\text{ }^{\circ}\text{C}$ for 30 minutes 3. repeat 100 cycle						
Vibration		Frequency : 10 ~ 55 Hz Amplitude : 1.5 mm Direction : X, Y, Z Sweep time : 2 hours for each axis						
Drop		Drop 10 times on a concrete floor from a height of 100 cm						
Flexure strength	No mechanical damage							
	ITEM	1005	1608	2012	3216	4516	4532	
	A (mm)	0.7	1.0	1.0	1.3	1.5	1.5	
	B (mm)	0.5	0.8	1.0	1.5	3.6	3.6	
	C (mm)	0.7	1.3	1.3	3.0	3.0	3.8	
	W (kgf)	0.7	2.0	4.0	5.0	5.0	5.0	
Bending strength	The terminal electrode shall be neither break off nor the chip damage							

Packaging

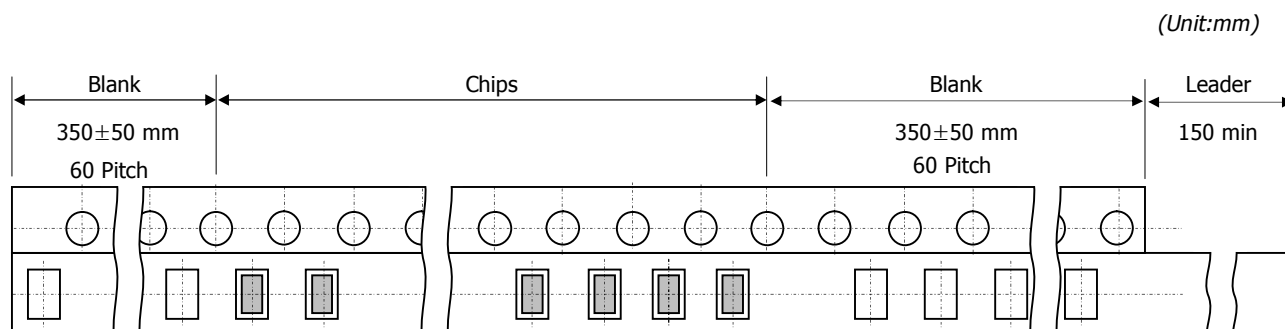
❖ Standard Quantity

Size	Q'TY(PCS)	Remarks
1005	10,000	
1608	4,000	
2012	4,000	0.85 T size
3216	3,000	
4516	2,000	
4532	1,000	

❖ Reel Dimension



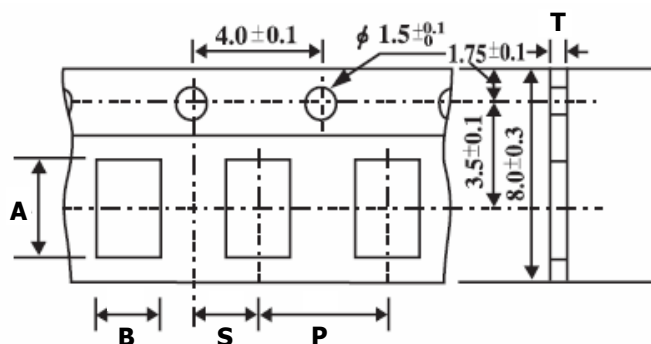
❖ Leader & Blank Portion



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Packaging

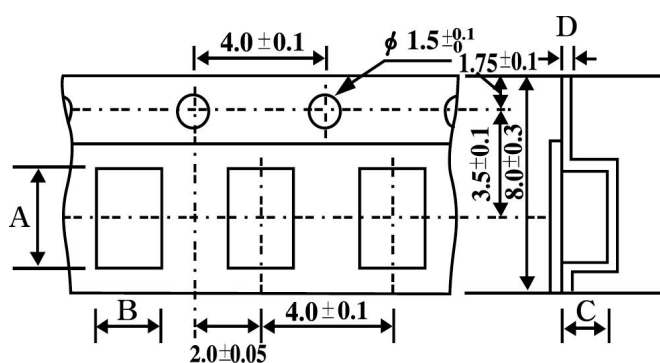
❖ Taping Dimensions (Paper tape)



(Unit:mm)

Type	A ±0.1	B ±0.1	P ±0.1	S ±0.1	T (Max.)
1005	1.15	0.65	2.0	1.0	0.8
1608	1.80	1.00	4.0	2.0	1.1
2012	2.30	1.55	4.0	2.0	1.1

❖ Taping Dimensions (Emboss tape)



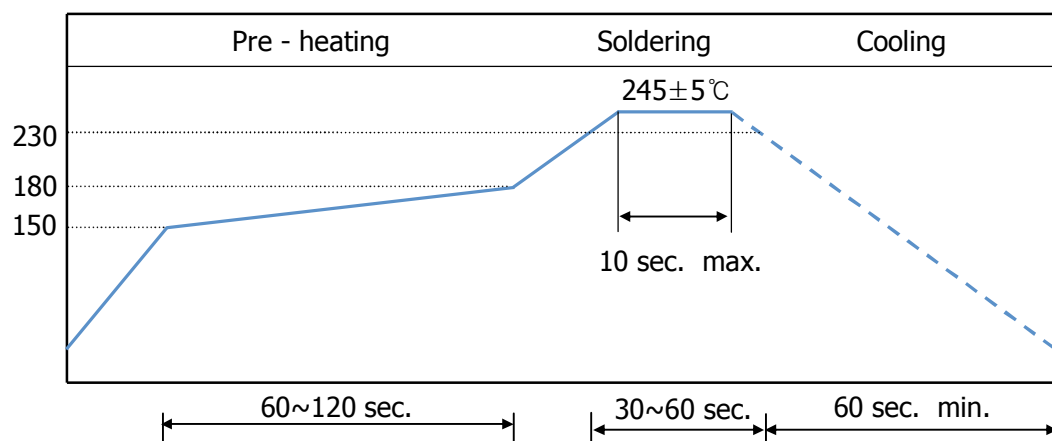
(Unit:mm)

Type	A ±0.1	B ±0.1	C ±0.1	D ±0.1
2012	2.25	1.45	1.50	0.23
3216	3.50	1.85	1.25	0.23
4516	4.90	1.90	1.35	0.30
4532	4.85	3.60	1.40	0.30

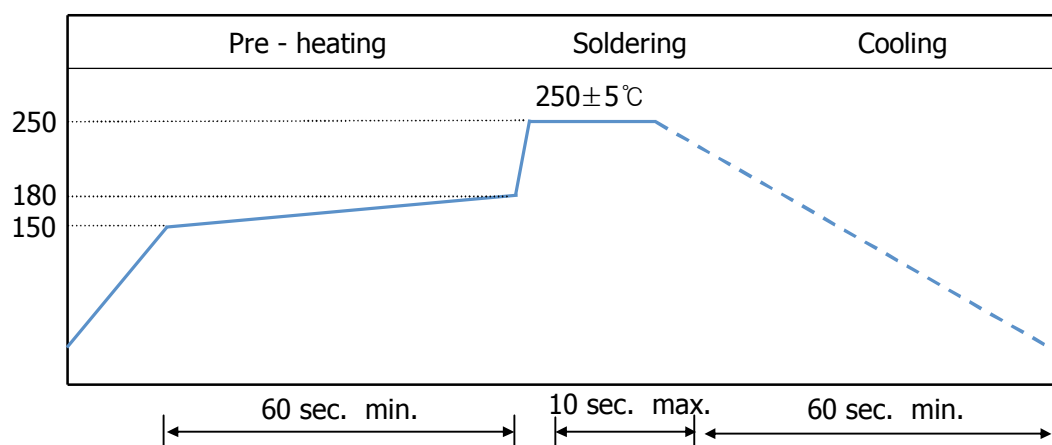
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Soldering Profile

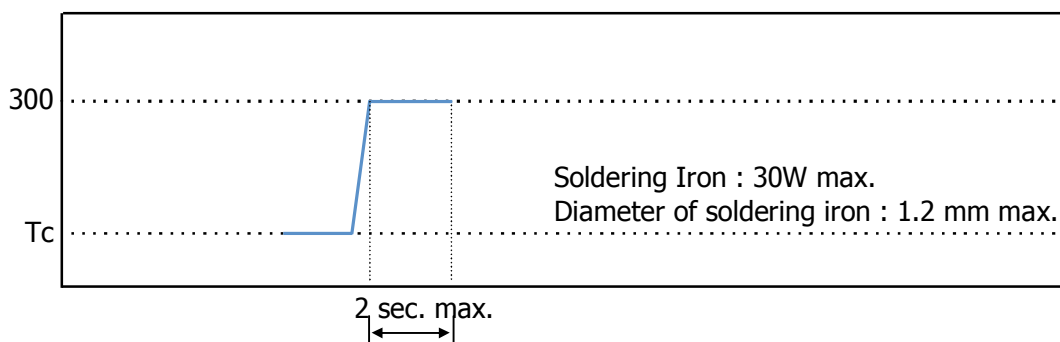
❖ Reflow Soldering



❖ Flow Soldering



❖ Manual Soldering



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